# CEP7060L/CEB7060L

CET

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N-Channel Logic Level Enhancement Mode Field Effect

FEATURES

- 60V , 75A , $R_{DS(ON)}$=14mΩ @V_{GS}=5V.
- Super high dense cell design for extremely low $R_{DS(ON)}$.
- High power and current handling capability.
- TO-220 & TO-263 package.

CEB SERIES
TO-263(DD-PAK)

CEP SERIES
TO-220

D

G

S
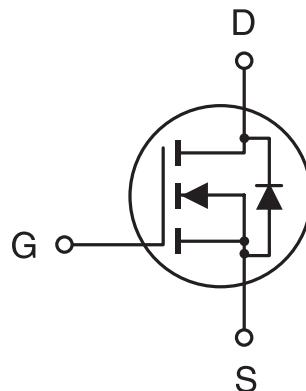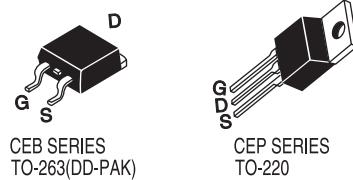
ABSOLUTE MAXIMUM RATINGS (Tc=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	±20	V
Drain Current-Continuous	I_D	75	A
-Pulsed	I_{DM}	225	A
Drain-Source Diode Forward Current	I_S	75	A
Maximum Power Dissipation @Tc=25°C	P_D	150	W
Derate above 25°C		1	W/°C
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to 175	°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	1	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	°C/W

ELECTRICAL CHARACTERISTICS (Tc=25°C unless otherwise noted)

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Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V$, $I_D=250\mu A$	60			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=60V$, $V_{GS}=0V$			25	μA
Gate-Body Leakage	I_{GSS}	$V_{GS}=\pm20V$, $V_{DS}=0V$			±100	nA
ON CHARACTERISTICS[a]						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$	1	1.3	2	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	$V_{GS}=5V$, $I_D=37.5A$		10	14	$m\Omega$
On-State Drain Current	$I_{D(ON)}$	$V_{GS}=5V$, $V_{DS}=10V$	60			A
Forward Transconductance	g_{FS}	$V_{DS}=10V$, $I_D=37.5A$		60		S
DYNAMIC CHARACTERISTICS[b]						
Input Capacitance	C_{ISS}	$V_{DS}=25V$, $V_{GS}=0V$ $f=1.0MHz$		2730	3600	pF
Output Capacitance	C_{OSS}			723	1000	pF
Reverse Transfer Capacitance	C_{RSS}			128	170	pF
SWITCHING CHARACTERISTICS[b]						
Turn-On Delay Time	$t_{D(ON)}$	$V_{DD}=30V$, $I_D=75A$, $V_{GS}=5V$, $R_{GEN}=10\Omega$		20	40	ns
Rise Time	t_r			440	600	ns
Turn-Off Delay Time	$t_{D(OFF)}$			80	150	ns
Fall Time	t_f			250	400	ns
Total Gate Charge	Q_g	$V_{DS}=48V$, $I_D=75A$, $V_{GS}=5V$		104	115	nC
Gate-Source Charge	Q_{gs}			14		nC
Gate-Drain Charge	Q_{gd}			18		nC

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ELECTRICAL CHARACTERISTICS (Tc=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
DRAIN-SOURCE DIODE CHARACTERISTICS [a]						
Diode Forward Voltage	V_{SD}	V_{GS} = 0V, Is =37.5A		0.86	1.3	V

Notes

a.Pulse Test:Pulse Width ≤300 μs, Duty Cycle ≤ 2%.

b.Guaranteed by design, not subject to production testing.
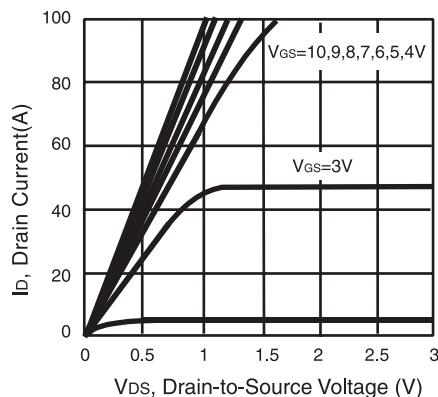
Figure 1. Output Characteristics
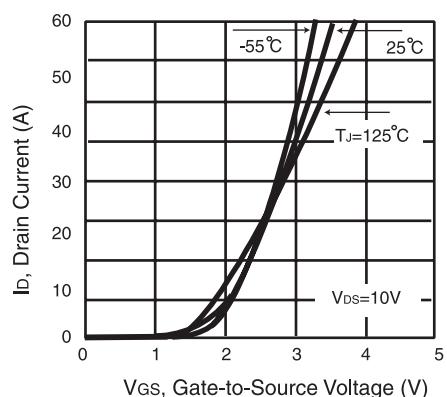
Figure 2. Transfer Characteristics
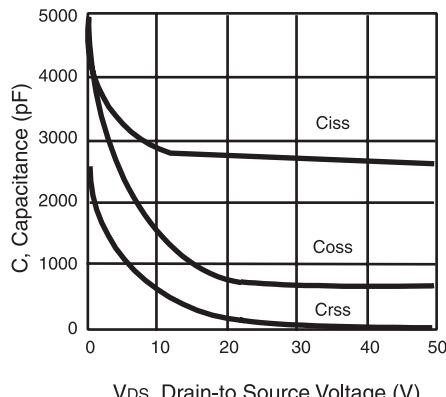
Figure 3. Capacitance
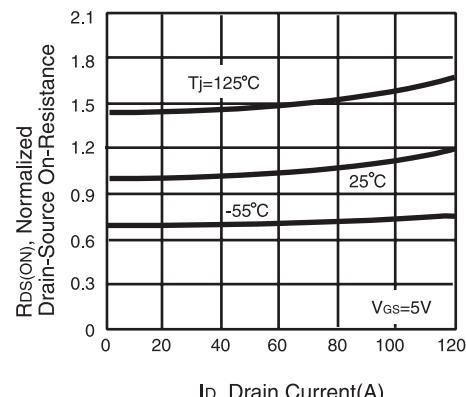
Figure 4. On-Resistance Variation with Drain Current and Temperature

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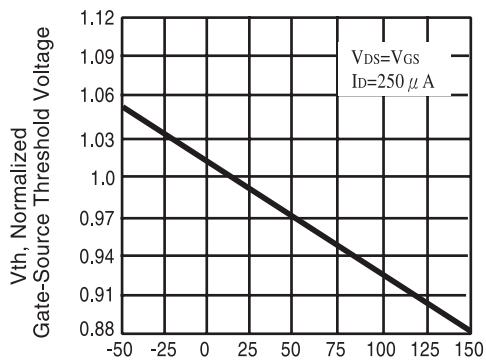
Figure 5. Gate Threshold Variation
with Temperature
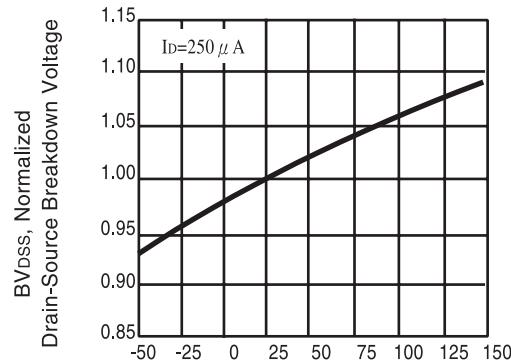
Figure 6. Breakdown Voltage Variation
with Temperature
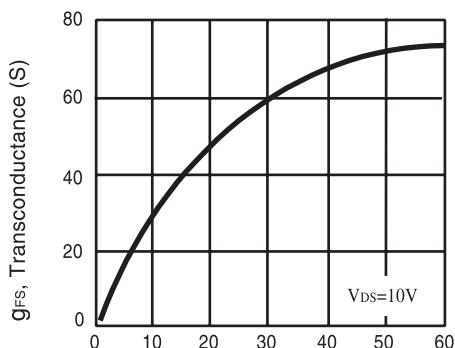
Figure 7. Transconductance Variation
with Drain Current
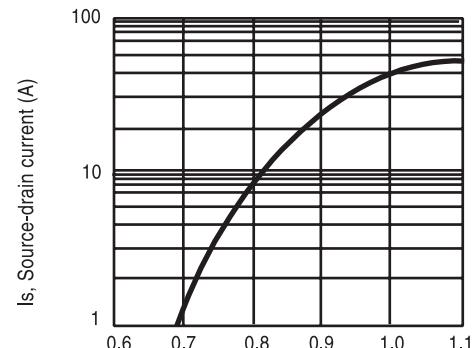
Figure 8. Body Diode Forward Voltage
Variation with Source Current
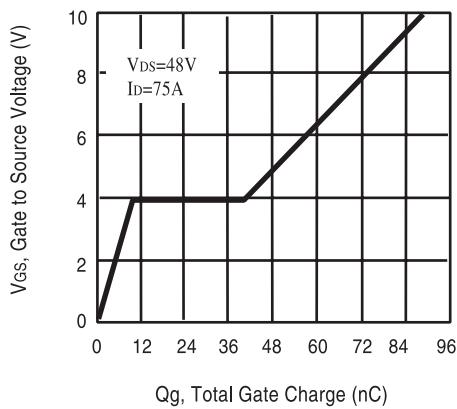
Figure 9. Gate Charge
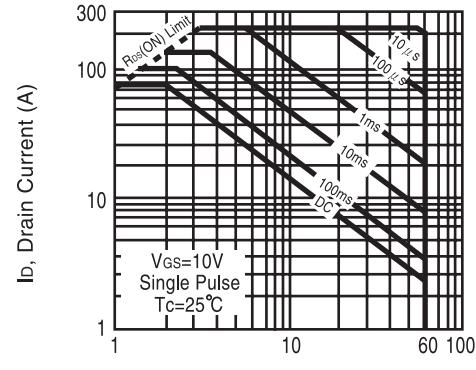
Figure 10. Maximum Safe
Operating Area

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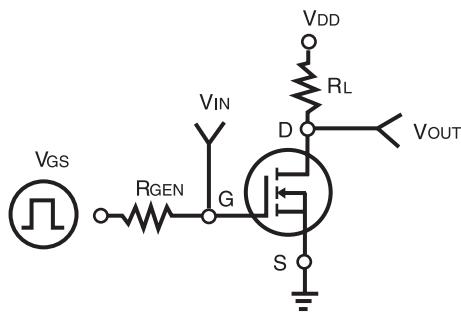
**Figure 11. Switching Test Circuit**
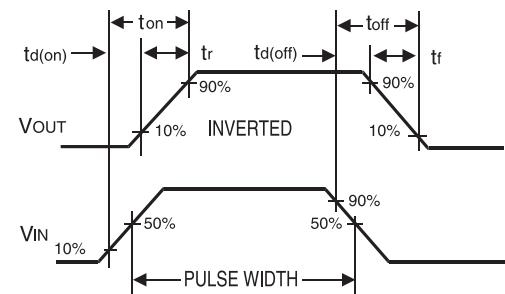
Figure 12. Switching Waveforms
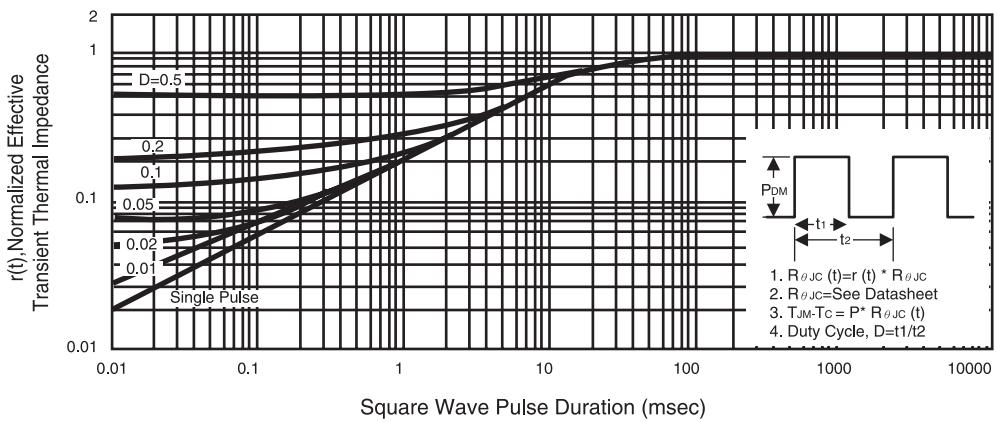
Figure 13. Normalized Thermal Transient Impedance Curve